

SANYO Semiconductors DATA SHEET

CPH3147 –

PNP Epitaxial Planar Silicon Transistor

High-Current Switching Applications

Applications

• DC / DC converter, Relay drivers, lamp drivers, motor drivers.

Features

- · Adoption of FBET, MBIT processes.
- · High current capacitance.
- · Low collector-to-emitter saturation voltage.
- · High-speed switching.
- Ultrasmall package facilitates miniaturization in end products (mounting height: 0.9mm).
- · High allowable power dissipation.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		-80	V
Collector-to-Emitter Voltage	VCES		-80	V
Collector-to-Emitter Voltage	VCEO		-80	V
Emitter-to-Base Voltage	VEBO		-7	V
Collector Current	Ic		-2.5	Α
Collector Current (Pulse)	ICP		-4	Α
Base Current	IB		-500	mA
Collector Dissipation	PC	Mounted on a ceramic board (600mm ² X0.8mm)	0.9	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions		Ratings		
	Symbol		min	typ	max	Unit
Collector Cutoff Current	ICBO	VCB=-70V, IE=0A			-1	μΑ
Emitter Cutoff Current	I _{EBO}	V _{EB} =-4V, I _C =0A			-1	μΑ
DC Current Gain	hFE	V _{CE} =-5V, I _C =-100mA	200		400	
Gain-Bandwidth Product	fT	VCE=-10V, IC=-500mA		350		MHz
Output Capacitance	Cob	V _{CB} =-10V, f=1MHz		23		pF

Marking: BN Continued on next page.

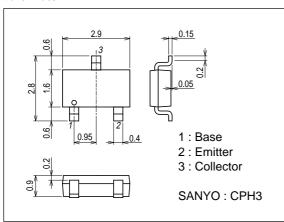
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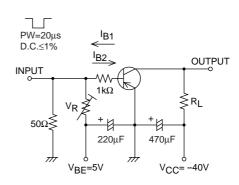
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Collector-to-Emitter Saturation Voltage	VCE(sat)	IC=-1A, IB=-100mA		-85	-170	mV
Base-to-Emitter Saturation Voltage	V _{BE} (sat)	I _C =-1A, I _B =-100mA		-0.85	-1.2	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	IC=-10μA, IE=0A	-80			V
Collector-to-Emitter Breakdown Voltage	V(BR)CES	IC=-100μA, RBE=0Ω	-80			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=-1mA, RBE=∞	-80			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	IE=-10μA, IC=0A	-7			V
Turn-ON Time	ton	See specified test circuit.		40		ns
Storage Time	tstg	See specified test circuit.		500		ns
Fall Time	tf	See specified test circuit.		28		ns

Package Dimensions

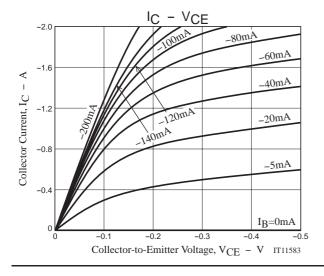
unit : mm (typ) 7015A-003

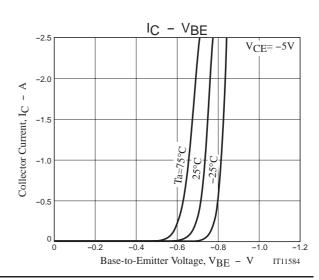


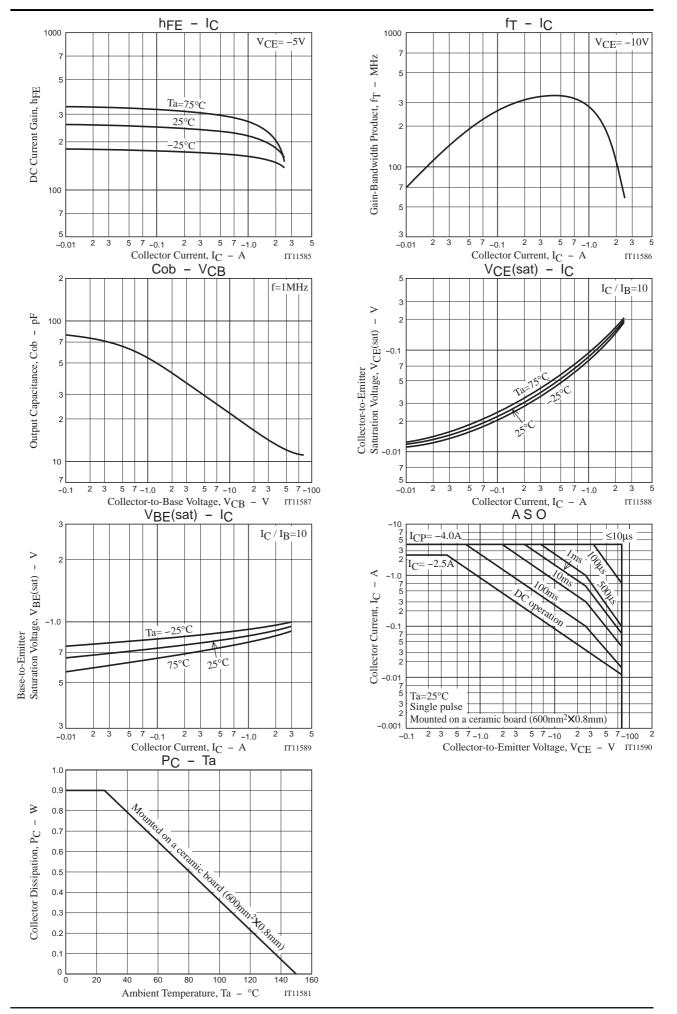
Switching Time Test Circuit



$$I_{C} = -10I_{B1} = 10I_{B2} = I_{C} = -0.5A$$







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